120. (Previously Cancelled) A device of claim 117, wherein said vertically oriented carbon nanotube is at least partially electrically isolated from the said substrate.

## 121. (Cancelled) A device comprising:

at least one vertically oriented carbon nanotube;

at least one horizontal conductive layer, wherein the said horizontal conductive layer is electrically coupled to said vertically oriented carbon nanotube; and

wherein the said horizontal conductive layer includes patterned lines.

- 122. (Previously Cancelled)
- 123. (Previously Cancelled).
- 124. (Cancelled) A device of claim 121, wherein said carbon nanotube is conductive.
- 125. (Cancelled) A device of claim 121, wherein said horizontal conductive layer material comprises a member of the class consisting of aluminum, copper, tungsten, titanium, nickel, chromium, and their alloys.
- 126. (Previously Cancelled) A device comprising:

at least one vertically aligned carbon nanotube, wherein said vertically aligned carbon nanotube is fabricated within vertically aligned holes within a substrate material;

at least one horizontal conducting interconnect, wherein said interconnect is electrically coupled to said vertically aligned carbon nanotube; and

wherein a plurality of said vertically aligned carbon nanotubes form a pattern in the said substrate material.

127. (Previously Cancelled) A device of claim 126, wherein said substrate material comprises a member of the class consisting of silicon, silicon nitride, silicon dioxide, aluminum, alumina, and gallium arsenide.

## 128. (Previously Cancelled)

- 129. (Previously Cancelled) A device comprising:
  - a first electronic device having at least one logic device;
  - a second electronic device having at least one logic device; and
- at least one carbon nanotube, wherein the said carbon nanotube is electrically coupled to said first electronic device and said second electronic device.
- 130. (Previously Cancelled) A device of claim 129, wherein said carbon nanotube is a vertically oriented carbon nanotube.
- 131. (Previously Cancelled) A device of claim 129, wherein said carbon nanotube is a horizontally oriented carbon nanotube.
- 132. (Previously Cancelled)
- 133. (Previously Cancelled) A device having plurality of carbon nanotubes in a substrate comprising:
  - a first carbon nanotube;
  - a second carbon nanotube; and

wherein said first carbon nanotube crosses path with said second carbon nanotube at a point such that said first carbon nanotube and said second carbon nanotube are electrically coupled.

- 134. (Cancelled) A device comprising:
- at least one vertically oriented carbon nanotube embedded in a substrate, wherein the said nanotube is protruding from the said substrate;
- at least one horizontal conductive layer, wherein the said horizontal conductive layer is electrically coupled to said vertically oriented carbon nanotube; and

wherein the said horizontal conductive layer includes patterned lines.

- 135. (Previously Cancelled) A device comprising:
- at least one vertically oriented carbon nanotube, wherein said carbon nanotube is conductive; and
- at least one horizontal conductive layer, wherein the said horizontal conductive layer is electrically coupled to said vertically oriented carbon nanotube.

136. (Previously Cancelled) A device of claim 135, wherein the said horizontal conductive layer includes a blanket deposited film.

## 137. (New) A device comprising:

at least one carbon nanotube electrically coupled to a patterned conductive layer within a horizontally oriented substrate, wherein substantially all of the carbon nanotubes are vertically oriented.

- 138. (New) The device of Claim 137, wherein the at least one vertically oriented carbon nanotube is partially embedded within the substrate.
- 139. (New) The device of Claim 137, wherein the at least one vertically oriented carbon nanotube is fully embedded within the substrate without protruding beyond the substrate.
- 140. (New) The device of Claim 137, wherein the at least one vertically oriented carbon nanotubes is disposed outwardly from the substrate.
- 141. (New) The device of Claim 137, wherein the substrate comprises a substrate material from a class consisting of undoped silicon, doped silicon, crystalline silicon, polysilicon, silicon nitride, undoped silicon dioxide, and doped silicon dioxide.
- 142. (New) The device of Claim 137, wherein at least one vertically oriented carbon nanotube is electrically isolated from the substrate.
- 143. (New) The device of Claim 137, wherein the at least one vertically oriented nanotube is fabricated within a specified area of the substrate.
- 144. (New) A device of claim 137, comprising a second patterned conductive layer within the horizontally oriented substrate.
- 145. (New) A device of claim 137, wherein the carbon nanotube is fabricated within vertically aligned hole within the substrate, wherein the hole has a nano-sized diameter.
- 146. (New) A device of Claim 145, wherein the hole diameter is preferably in the range from about 1 nanometer to about 50 nanometers.

- 147. (New) The device of Claim 137, wherein said carbon nanotube is conductive.
- 148. (New) A device of claim 137, wherein the conductive layer material comprises a member of the class consisting of aluminum, copper, tungsten, titanium, nickel, chromium, and their alloys.